

SEIKO EPSON CORPORATION

TCXO / TCXO-Standby 105 °C High temperature range

TG1612SLN

- 1 1 2	13 MHz to 55.2 MHz 1.8 V Typ./ 2.8 V Typ./ 3.0 V Typ./ 3.3 V Typ.
 Frequency / tempera 	ure characteristics
	±0.5 × 10 ⁻⁶ Max. (-40 °C to +85 °C) and
	±5.0 × 10 ⁻⁶ Max. (+85 °C to +105 °C)
 External dimensions 	1.6 × 1.2 × 0.45 mm Max.
 Applications 	Smart phone, LPWA module
	Wireless communication devices
 Features 	105 °C High temp, Standby function (\overline{ST})



Product Number TG1612SLN : X1G005721xxxx16



TG1612SLN $(1.6 \times 1.2 \times 0.45 \text{ mm})$

Specifications (characteristics)							
Item	Symbol	ТСХО	TCXO-Standby	Conditions / Remarks			
Output frequency range	fo	13 MHz to	55.2 MHz				
Output frequency range	10	26 N	MHz	Standard frequency			
Supply voltage	Vcc	1.8 V ±0.1 V / 2.8 V ±5 %	/ 3.0 V ±5 % / 3.3 V ±5 %	Supply voltage range :1.7 V to 3.63 V			
Storage temperature range	T_stg	-40 °C to +125 °C		Storage as single product.			
Operating temperature range	T_use	G: -40 °C to +85 °C / H: -40 °C to +105 °C					
Frequency tolerance	f_tol	±2.0 × 1	0 ⁻⁶ Max.	After reflow, +25 °C			
Frequency/temperature	fo-Tc	C: ±0.5 × 10 ⁻⁶ Max. / -40 °C to +85 °C		Standard stability version			
characteristics		W: And $\pm 5.0 \times 10^{-6}$ Max. / +85 °C to +105 °C (Option)		Customized product (Option)			
Frequency/load coefficient	fo-Load	±0.2 × 10 ⁻⁶ Max.		10 kΩ // 10 pF ±10 %			
Frequency/voltage coefficient	fo-Vcc	±0.2 × 10 ⁻⁶ Max.		$Vcc \pm 5$ %			
Frequency aging	f_age	±1.0 × 10 ^{.6} Max.		+25 °C, First year, 13 MHz≤ fo ≤20 MHz,			
				26 MHz≤ fo ≤40 MHz			
Frequency aging		$\pm 1.5 \times 10^{\text{-6}}$ Max.		+25 °C ,First year, 20 MHz< fo <26 MHz			
				40 MHz< fo ≤55.2 MHz			
Current consumption	Icc	1.5 mA Max.		13 MHz < fo ≤26 MHz (-40 to +85 °C)			
		1.7 mA Max.		13 MHz < fo ≤26 MHz (-40 to +105 °C)			
		2.0 mA Max.		26 MHz < fo ≤38.4 MHz (-40 to +105 °C)			
		2.5 mA Max.		38.4 MHz< fo ≤55.2 MHz (-40 to +105 °Ć)			
Stand-by current	I_std	-	3 µA Max.	$\overline{ST} = GND$			
Input voltage	VIH	- 80 % Vcc Min. - 20 % Vcc Max.		- 80 % Vcc Min.		- <u>s⊤</u> terminal	
	VIL						
Symmetry	SYM	40 % to	o 60 %	GND level (DC cut)			

0.8 V Min.

2.0 ms Max.

10 kΩ

Load_R Output load 10 pF Load_C Note : Please contact us for requirements not listed in this specification.

VPP

t_str

 $\frac{\text{TG1612 SLN 26.00000MHz}}{\textcircled{1}} \underbrace{\begin{array}{c} \textbf{E} \\ \textbf{\Psi} \end{array}}_{\textcircled{1}} \underbrace{\begin{array}{c} \textbf{W} \\ \textbf{G} \end{array}}_{\textcircled{1}} \underbrace{\begin{array}{c} \textbf{S} \\ \textbf{N} \end{array}}_{\textcircled{1}} \underbrace{\textbf{M}}_{\textcircled{1}} \underbrace{\textbf{S}}_{\textcircled{1}} \underbrace{\textbf{N}}_{\textcircled{1}} \underbrace{\textbf{M}}_{\textcircled{1}} \underbrace{\textbf{S}}_{\textcircled{1}} \underbrace{\textbf{N}}_{\textcircled{1}} \underbrace{\textbf{M}}_{\textcircled{1}} \underbrace{\textbf{S}}_{\textcircled{1}} \underbrace{\textbf{N}}_{\textcircled{1}} \underbrace{\textbf{M}}_{\textcircled{1}} \underbrace{\textbf{M}}_{\textbf{M}} \underbrace{\textbf{M}} \underbrace{\textbf{M}} \underbrace{\textbf{M}}_{\textbf{M}} \underbrace{\textbf{M}} \underbrace{\textbf{M}$ Product Name (Standard form)

④Supply voltage[Vcc],⑧Vc function[Vc] (Symbol table)						
④,⑧Type: Function	Suffix symbol: Voltage(Typ.) [V]					
④Vcc: Common	E: 1.8	B: 2.8	A: 3.0	C: 3.3		
⑧Vc:	N: Non					

Peak to Peak

T=0 at 90 % Vcc

DC cut capacitor = 0.01 µF

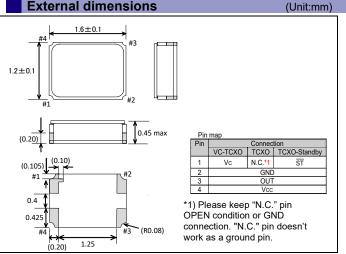
①Model ②Output (S: Clipped sine wave) ③Frequency ④Supply voltage (Refer to symbol table)

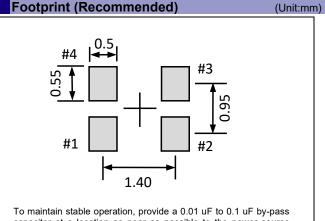
5 Frequency / temperature characteristics (C: $\pm 0.5 \times 10^{-6}$ Max., F: $\pm 2.0 \times 10^{-6}$ Max., W: $\pm 0.5 \times 10^{-6}$ Max. and $\pm 5.0 \times 10^{-6}$ Max.) ⑥Operating temperature (H: -40 °C to +105 °C, G: -40 °C to +85 °C) ⑦ST function (N: Non, S: Standby)



Output voltage

Start-up time





capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

Explanation of the mark that are using it for the catalog

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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